L Number	Hits	Search Text	DB	Time stamp
-	561	(156/166).CCLS.	USPAT;	2004/06/24 10:59
		(1001.120).	US-PGPUB;	
		·	EPO; JPO;	
]			DERWENT:	
			IBM_TDB	
_	737	(156/167).CCLS.	USPAT;	2004/06/24 10:59
	'"	(100/101/:0020:	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
_	44	(156/168).CCLS.	USPAT;	2004/06/24 10:59
	1	(188,188).8828.	US-PGPUB,	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
_	410	(156/169).CCLS.	USPAT;	2004/06/24 10:59
-	710	(100/100).0020.	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM TDB	
	112	(156/170).CCLS.	USPAT;	2004/06/24 10:59
-	112	(130/170).0023.	US-PGPUB;	200 1100121 10:00
			EPO; JPO;	1
			DERWENT;	
]		IBM_TDB	
	305	(156/171).CCLS.	USPAT;	2004/06/24 10:59
-	303	(150/1/1).CCL3.	US-PGPUB;	2004/00/24 10:00
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	•
	822	/456/470\ CCLS	USPAT;	2004/06/24 10:59
-	022	(156/172).CCLS.	US-PGPUB;	2004/00/24 10:55
			EPO; JPO;	
	1		DERWENT;	
			IBM_TDB	!
ŀ	720	(156/173).CCLS.	USPAT;	2004/06/24 10:59
-	729	(150/1/3).CCLS.	US-PGPUB;	2004/00/24 10.55
			EPO; JPO;	
			DERWENT;	
	1		IBM_TDB	
	244	(156/174) CCLS	USPAT;	2004/06/24 10:59
-	241	(156/174).CCLS.	US-PGPUB;	200-700/24 10.00
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
	558	(156/175).CCLS.	USPAT;	2004/06/24 10:59
-	556	(1307173).CCL3.	US-PGPUB;	2004/00/24 10:03
			EPO; JPO;	
			DERWENT;	
	207	(456/476) COLS	IBM_TDB USPAT;	2004/06/24 10:59
-	297	(156/176).CCLS.	USPAT; US-PGPUB;	2004/00/24 10.09
[.			EPO; JPO;	
1			DERWENT;	
	005	(450/477) COLC	IBM_TDB	2004/06/24 40:50
-	265	(156/177).CCLS.	USPAT;	2004/06/24 10:59
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	

-	440	(156/178).CCLS.	USPAT;	2004/06/24 10:59
			US-PGPUB;	
			EPO; JPO;	ļ
			DERWENT;	
			IBM_TDB	
-	336	(156/179).CCLS.	USPAT;	2004/06/24 10:59
1			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
_	836	(156/180).CCLS.	USPAT;	2004/06/24 10:59
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	842	(156/181).CCLS.	USPAT;	2004/06/24 10:59
			US-PGPUB;	
	1		EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	709	(156/184).CCLS.	USPAT;	2004/06/24 10:59
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	338	(156/185).CCLS.	USPAT;	2004/06/24 10:59
			US-PGPUB;	
			EPO; JPO;	
	İ		DERWENT;	
			IBM_TDB	
-	66	(156/186).CCLS.	USPAT;	2004/06/24 10:59
1			US-PGPUB;	
		•	EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	752	(156/187).CCLS.	USPAT;	2004/06/24 10:59
			US-PGPUB;	
	1		EPO; JPO;	
			DERWENT;	
			IBM_TDB	0004/00/04 40:50
-	256	(156/188).CCLS.	USPAT;	2004/06/24 10:59
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
		(450(400) 001.0	IBM_TDB	2004/08/24 40:50
-	340	(156/189).CCLS.	USPAT; US-PGPUB;	2004/06/24 10:59
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
	420	(456(400) CCLS	USPAT;	2004/06/24 10:59
-	438	(156/190).CCLS.	US-PGPUB;	2007/00/27 10:09
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
	423	(156/191).CCLS.	USPAT;	2004/06/24 10:59
-	423	(100/181).00L0.	US-PGPUB;	
	1		EPO; JPO;	
			DERWENT;	
			IBM_TDB	
	388	(156/192).CCLS.	USPAT;	2004/06/24 10:59
_	308	(100) 192).COLO.	US-PGPUB;	230 1100124 10.03
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
·	l		ם חו בואוחו ב	l

	200	(4EG/402) COLC	USPAT;	2004/06/24 10:59
-	289	(156/193).CCLS.	US-PGPUB;	2004/06/24 10:59
			EPO; JPO;	
			DERWENT:	
			IBM_TDB	
-	311	(156/194).CCLS.	USPAT;	2004/06/24 10:59
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	752	(156/195).CCLS.	USPAT;	2004/06/24 10:59
	1		US-PGPUB;	·
	1		EPO; JPO; DERWENT;	
			IBM_TDB	
_	7059	((156/166).CCLS.) ((156/167).CCLS.) ((156/168).CCLS.)	USPAT	2004/06/24 10:59
	, , , ,	((156/169).CCLS.) ((156/170).CCLS.) ((156/171).CCLS.)	00.7.1	200 1/00/21 10:00
ļ		((156/172).CCLS.) ((156/173).CCLS.) ((156/174).CCLS.)		
		((156/175).CCLS.) ((156/176).CCLS.) ((156/177).CCLS.)	`	
		((156/178).CCLS.) ((156/179).CCLS.) ((156/180).CCLS.)		
		((156/181).CCLS.) ((156/184).CCLS.) ((156/185).CCLS.)		
		((156/186).CCLS.) ((156/187).CCLS.) ((156/188).CCLS.)		,
ľ		((156/189).CCLS.) ((156/190).CCLS.) ((156/191).CCLS.)		
		((156/192).CCLS.) ((156/193).CCLS.) ((156/194).CCLS.)	ļ	
	8511	((156/195).CCLS.)	USPAT:	2004/06/24 10:59
-	6511	((156/166).CCLS.) ((156/167).CCLS.) ((156/168).CCLS.) ((156/169).CCLS.) ((156/170).CCLS.) ((156/171).CCLS.)	US-PGPUB;	2004/06/24 10.59
		((156/172).CCLS.) ((156/173).CCLS.) ((156/174).CCLS.)	EPO; JPO;	
		((156/175).CCLS.) ((156/176).CCLS.) ((156/177).CCLS.)	DERWENT;	
		((156/178).CCLS.) ((156/179).CCLS.) ((156/180).CCLS.)	IBM_TDB	
		((156/181).CCLS.) ((156/184).CCLS.) ((156/185).CCLS.)	-	
		((156/186).CCLS.) ((156/187).CCLS.) ((156/188).CCLS.)		
		((156/189).CCLS.) ((156/190).CCLS.) ((156/191).CCLS.)		
		((156/192).CCLS.) ((156/193).CCLS.) ((156/194).CCLS.)		
		((156/195).CCLS.)		
-	3	(fiber near2 (placement)) and(molecular near10 mobility)	USPAT;	2004/06/24 10:59
			US-PGPUB; EPO; JPO;	
	İ		DERWENT:	
			IBM TDB	
-	3	(fiber near2 (placement)) and (molecular near10 mobility)	USPAT;	2004/06/24 10:59
0)			US-PGPUB;	
		*	EPO; JPO;	
			DERWENT;	
		(IICODO 40 4II) EN	IBM_TDB	0004/00/04 40 55
-	1 250	("6096164").PN.	USPAT	2004/06/24 10:59
-	358	(156/351).CCLS.	USPAT;	2004/06/24 10:59
			US-PGPUB; EPO; JPO;	
			DERWENT;	
			IBM_TDB	
_	3	(("5698066") or ("5580413") or ("5228050")).PN.	USPAT	2004/06/24 10:59
-	7	(collation near2 (machine or apparatus or head)) and (laser	USPAT;	2004/06/24 10:59
]	near3 diode)	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
		· · · · · · · · · · · · · · · · · · ·	IBM_TDB	0004/00/54 := 5=
-	3	(compaction near2 (machine or apparatus or head)) and	USPAT;	2004/06/24 10:59
		(laser near3 diode)	US-PGPUB;	
			EPO; JPO; DERWENT;	
			IBM TDB	
	L	L	טט ז _ועוטי	

	117	(fiber near2 (placement)) and (laser near3 diode)	USPAT;	2004/06/24 10:59
	111	(liber flear2 (placement)) and (laser flearo diode)	US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/00/24 10:35
-	1	(((156/166).CCLS.) ((156/167).CCLS.) ((156/168).CCLS.) ((156/169).CCLS.) ((156/170).CCLS.) ((156/171).CCLS.) ((156/172).CCLS.) ((156/173).CCLS.) ((156/174).CCLS.) ((156/175).CCLS.) ((156/176).CCLS.) ((156/177).CCLS.) ((156/178).CCLS.) ((156/179).CCLS.) ((156/180).CCLS.) ((156/181).CCLS.) ((156/184).CCLS.) ((156/185).CCLS.) ((156/186).CCLS.) ((156/187).CCLS.) ((156/188).CCLS.) ((156/189).CCLS.) ((156/190).CCLS.) ((156/191).CCLS.) ((156/192).CCLS.) ((156/193).CCLS.) ((156/195).CCLS.) ((156/195).CCLS.)) and (laser near3 array) and (laser near3 diode)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/24 10:59
-	6	(((156/166).CCLS.) ((156/167).CCLS.) ((156/168).CCLS.) ((156/169).CCLS.) ((156/170).CCLS.) ((156/171).CCLS.) ((156/172).CCLS.) ((156/173).CCLS.) ((156/174).CCLS.) ((156/175).CCLS.) ((156/176).CCLS.) ((156/177).CCLS.) ((156/178).CCLS.) ((156/178).CCLS.) ((156/184).CCLS.) ((156/185).CCLS.) ((156/186).CCLS.) ((156/187).CCLS.) ((156/188).CCLS.) ((156/189).CCLS.) ((156/190).CCLS.) ((156/191).CCLS.) ((156/192).CCLS.) ((156/193).CCLS.) ((156/194).CCLS.) ((156/195).CCLS.)) and (laser near3 diode)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/24 10:59
	3	(((156/166).CCLS.) ((156/167).CCLS.) ((156/168).CCLS.) ((156/169).CCLS.) ((156/170).CCLS.) ((156/171).CCLS.) ((156/172).CCLS.) ((156/173).CCLS.) ((156/174).CCLS.) ((156/175).CCLS.) ((156/176).CCLS.) ((156/177).CCLS.) ((156/178).CCLS.) ((156/179).CCLS.) ((156/180).CCLS.) ((156/181).CCLS.) ((156/184).CCLS.) ((156/185).CCLS.) ((156/186).CCLS.) ((156/187).CCLS.) ((156/188).CCLS.) ((156/189).CCLS.) ((156/190).CCLS.) ((156/191).CCLS.) ((156/192).CCLS.) ((156/193).CCLS.) ((156/194).CCLS.) ((156/195).CCLS.)) and (laser near3 array)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/24 10:59
-	422	(156/359).CCLS. //	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/06/24 10:59
-	363	(156/358).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/24 11:00
-	185	(fiber near2 (placement)) and (camera or CCD)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/24 10:59
-	1 52	("5066352").PN. (fiber near2 (placement)) and (pressure near2 control)	USPAT USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/06/24 11:00 2004/06/24 11:00
-	27	(fiber near2 (tape)) and (pressure near2 control)	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/24 11:00

-	356	(156/379.6).CCLS.	USPAT;	2004/06/24 11:01
		,	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
l <u>-</u>	227	(156/380.9).CCLS.	USPAT;	2004/06/24 11:04
		,	US-PGPUB,	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
_	621	(156/378).CCLS.	USPAT;	2004/06/24 11:04
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
_	170	(156/379).CCLS.	USPAT;	2004/06/24 11:04
		,	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	



Day: Thursday Date: 6/24/2004

Time: 13:09:33

Inventor Name Search Result

Your Search was:

Last Name = HOLMES First Name = SCOTT

Application#	Patent#	Status	Date Filed	Title	Inventor Name 10
<u>60194847</u>	Not Issued	159	04/05/2000	TOP DOWN HORIZONTAL BLIND FOR REGULAR AND UNUSUALLY SHAPED WINDOWS	HOLMES, SCOTT DAVID
<u>10664148</u>	Not Issued	071	09/17/2003	COMPOSITE MATERIAL COLLATION MACHINE AND ASSOCIATED METHOD FOR HIGH RATE COLLATION OF COMPOSITE MATERIALS	HOLMES, SCOTT T.
<u>10068735</u>	Not Issued	120	02/06/2002	COMPOSITE MATERIAL COLLATION MACHINE AND ASSOCIATED METHOD FOR HIGH RATE COLLATION OF COMPOSITE MATERIALS	HOLMES, SCOTT T.
09899701	6503150	150	07/05/2001	GOLF PRACTICE DEVICE	HOLMES, SCOTT TRAVIS
09819922	Not Issued	030	03/28/2001	SYSTEM AND METHOD FOR IDENTIFYING DEFECTS IN A COMPOSITE STRUCTURE	HOLMES, SCOTT T.
09578069	6451152	150	05/24/2000	METHOD FOR HEATING AND CONTROLLING TEMPERATURE OF COMPOSITE MATERIAL DURING AUTOMATED PLACEMENT	HOLMES, SCOTT
08936632	6159705	150	09/24/1997	RECOMBINANT YEAST CELLS FOR IDENTIFYING RECEPTOR EFFECTORS	HOLMES, SCOTT
08580990	Not Issued	161	01/03/1996	THERALOSS/RX	HOLMES , SCOTT
08240279	5626471	150		ADJUSTABLE HOT GAS TORCH NOZZLE AND A METHOD FOR RAPID HEATING CONTROL	HOLMES , SCOTT

07699378 5225025 150 05/14/1991 APPARATUS AND METHOD HOLMES, SCOTT FOR RESISTANCE WELDING

Inventor Search Completed: No Records to Display.

Search Another: Inventor HOLMES First Name

Scott Scott Search

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Inventor Name Search Result

Your Search was:

Last Name = MCILROY

First Name = BRUCE

Application#	Patent#	Status	Date Filed	Title	Inventor Name 5
10664148	Not Issued			COMPOSITE MATERIAL	MCILROY, BRUCE E.
10068735	Not Issued	120	02/06/2002	COMPOSITE MATERIAL COLLATION MACHINE AND ASSOCIATED METHOD FOR HIGH RATE COLLATION OF COMPOSITE MATERIALS	MCILROY, BRUCE E.
09126561	6066389	150	07/30/1998	CONNECTOR TOW	MCILROY , BRUCE E.
<u>09126550</u>	5979046	150		COMPOSITE STRUCTURE HAVING AN EXTERNALLY ACCESSIBLE ELECTRICAL DEVICE EMBEDDED THEREIN AND A RELATED FABRICATION METHOD	MCILROY , BRUCE E.
<u>08473098</u>	<u>5851645</u>	150	06/07/1995	COMPOSITE STRUCTURE HAVING AN EXTERNALLY ACCESSIBLE ELECTRICAL DEVICE EMBEDDED THEREIN AND A RELATED FABRICATION METHOD	MCILROY , BRUCE E.

Inventor Search Completed: No Records to Display.

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MCILROY BRUCE Search

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Day: Thursday Date: 6/24/2004

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Inventor Name Search Result

Your Search was:

Last Name = ENGELBART

First Name = ROGER

	7	G	TO 1 1011 1	lens	
Application#					Inventor Name 9
10822538	Not Issued	020	04/12/2004	SYSTEMS AND METHODS FOR USING LIGHT TO INDICATE DEFECT LOCATIONS ON A COMPOSITE STRUCTURE	ENGELBART, ROGER W.
10799306	Not Issued	020	03/12/2004	SYSTEMS AND METHODS ENABLING AUTOMATED RETURN TO AND/OR REPAIR OF DEFECTS WITH A MATERIAL PLACEMENT MACHINE	ENGELBART, ROGER W.
10726099	Not Issued	020	12/02/2003	SYSTEMS AND METHODS FOR DETERMINING DEFECT CHARACTERISTICS OF A COMPOSITE STRUCTURE	ENGELBART, ROGER W.
10664148	Not Issued	071	09/17/2003	COMPOSITE MATERIAL COLLATION MACHINE AND ASSOCIATED METHOD FOR HIGH RATE COLLATION OF COMPOSITE MATERIALS	ENGELBART, ROGER W.
10628691	Not Issued	168	07/28/2003	SYSTEMS AND METHODS FOR IDENTIFYING FOREIGN OBJECTS AND DEBRIS (FOD) AND DEFECTS DURING FABRICATION OF A COMPOSITE STRUCTURE	ENGELBART, ROGER W.
10459957	Not Issued	030		APPARATUS AND METHODS FOR NON-DESTRUCTIVE INSPECTION USING MICROWAVE SENSING	ENGELBART, ROGER W.
10217805	Not Issued	071	08/13/2002	SYSTEM FOR IDENTIFYING DEFECTS IN A COMPOSITE STRUCTURE	ENGELBART, ROGER W.
10068735	Not	120	02/06/2002	COMPOSITE MATERIAL	ENGELBART,

	Issued		COLLATION MACHINE AND ASSOCIATED METHOD FOR HIGH RATE COLLATION OF COMPOSITE MATERIALS	ROGER W.
09819922	Not Issued	030	SYSTEM AND METHOD FOR IDENTIFYING DEFECTS IN A COMPOSITE STRUCTURE	11 , , , ,

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Day: Thursday Date: 6/24/2004

Time: 13:10:11

Inventor Name Search Result

Your Search was:

Last Name = LAWTON First Name = STANLEY

Application#	Patent#	Status	Date Filed	Title	Inventor Name 6
10664148	Not Issued	071	09/17/2003	COMPOSITE MATERIAL COLLATION MACHINE AND ASSOCIATED METHOD FOR HIGH RATE COLLATION OF COMPOSITE MATERIALS	LAWTON, STANLEY A.
10068735	Not Issued	120	02/06/2002	COMPOSITE MATERIAL COLLATION MACHINE AND ASSOCIATED METHOD FOR HIGH RATE COLLATION OF COMPOSITE MATERIALS	LAWTON, STANLEY A.
09578069	6451152	150	05/24/2000	METHOD FOR HEATING AND CONTROLLING TEMPERATURE OF COMPOSITE MATERIAL DURING AUTOMATED PLACEMENT	LAWTON, STANLEY A.
09451284	6347976	150	11/30/1999	COATING REMOVAL SYSTEM HAVING A SOLID PARTICLE NOZZLE WITH A DETECTOR FOR DETECTING PARTICLE FLOW AND ASSOCIATED METHOD	LAWTON , STANLEY ALLEN
08650644	Not Issued	148	05/23/1996	ELECTROMAGNETIC ABSORPTION SYSTEMS USING SOLID ACTIVE MATERIAL	LAWTON, STANLEY A.
08228592	5427763	250	04/15/1994	METHOD FOR MAKING VANADIUM DIOXIDE POWDERS	LAWTON , STANLEY A.

Inventor Search Completed: No Records to Display.

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